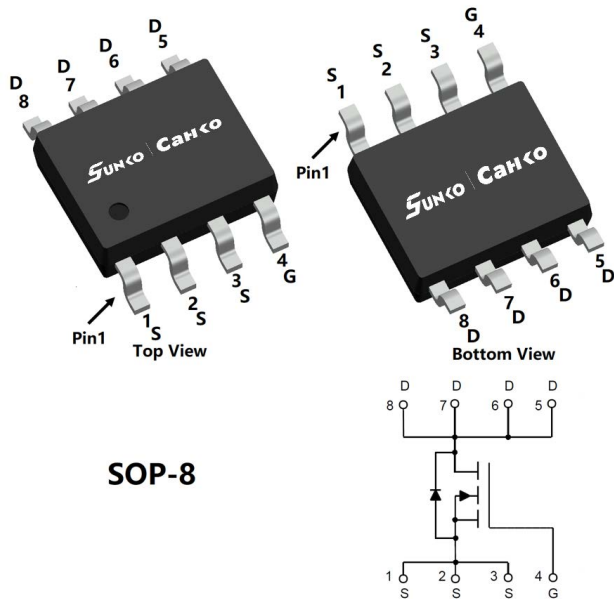


N-Channel Enhancement Mode Field Effect Transistor



Product Summary

• V_{DS}	100V
• I_D	15A
• $R_{DS(ON)}$ (at $V_{GS}=10V$)	<9.5 mohm
• 100% EAS Tested	

General Description

- Split Gate Trench MOSFET technology
- Excellent package for heat dissipation
- High density cell design for low $R_{DS(ON)}$
- Moisture Sensitivity Level 3
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free

Applications

- DC/DC Primary Side Switch
- Telecom/Server
- Synchronous Rectification

■ Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter		Symbol	Maximum	Unit
Drain-source Voltage		V_{DS}	100	V
Gate-source Voltage		V_{GS}	± 20	V
Drain Current	$T_A=25^\circ\text{C}$	I_D	15	A
	$T_A=100^\circ\text{C}$		9.5	
Pulsed Drain Current ^A		I_{DM}	75	A
Avalanche Energy, Single Pulse($L=0.5\text{mH}$)		E_{AS}	200	mJ
Total Power Dissipation ^B		P_D	3.8	W
Junction and Storage Temperature Range		T_J, T_{STG}	$-55 \sim +150$	$^\circ\text{C}$

■ Thermal resistance

Parameter		Symbol	Typ	Max	Units
Thermal Resistance Junction-to-Ambient ^C	$t \leq 10\text{S}$	$R_{\theta JA}$	25	32	$^\circ\text{C/W}$
Thermal Resistance Junction-to-Ambient ^C	Steady-State		47	60	
Thermal Resistance Junction-to-Lead	Steady-State	$R_{\theta JL}$	13	20	

■ Ordering Information (Example)

PREFERRED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
SCS15G10C	F2	Q15G10C	4000	8000	64000	13" reel

SCS15G10C

■ Electrical Characteristics (T_J=25°C unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} = 0V, I _D =250μA	100			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =100V,V _{GS} =0V, T _J =25℃			1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} = ±20V, V _{DS} =0V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D =250μA	2.0	2.8	4.0	V
Static Drain-Source On-Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =10A		8.0	9.5	mΩ
Diode Forward Voltage	V _{SD}	I _S =15A,V _{GS} =0V			1.3	V
Maximum Body-Diode Continuous Current	I _S				15	A
Gate resistance	R _G	f=1MHz, Open drain		0.68		Ω
Dynamic Parameters						
Input Capacitance	C _{iss}	V _{DS} =50V,V _{GS} =0V,f=1MHZ		2270		pF
Output Capacitance	C _{oss}			797		
Reverse Transfer Capacitance	C _{rss}			36		
Switching Parameters						
Total Gate Charge	Q _g	V _{GS} =10V,V _{DS} =50V,I _D =10A		32		nC
Gate-Source Charge	Q _{gs}			11.1		
Gate-Drain Charge	Q _{gd}			4.78		
Reverse Recovery Chrage	Q _{rr}	I _F =10A, di/dt=100A/us		84		nC
Reverse Recovery Time	t _{rr}			51.5		ns
Turn-on Delay Time	t _{D(on)}	V _{GS} =10V, V _{DD} =50V,I _D =10A R _{GEN} =2.2Ω		51		ns
Turn-on Rise Time	t _r			14.4		
Turn-off Delay Time	t _{D(off)}			69.2		
Turn-off fall Time	t _f			20.6		

A. Repetitive rating; pulse width limited by max. junction temperature.

B. Pd is based on max. junction temperature, using ≤10s junction-ambient thermal resistance.

C. The value of R_{θJA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A=25°C. The value in any given application depends on the user's specific board design.

■ Typical Performance Characteristics

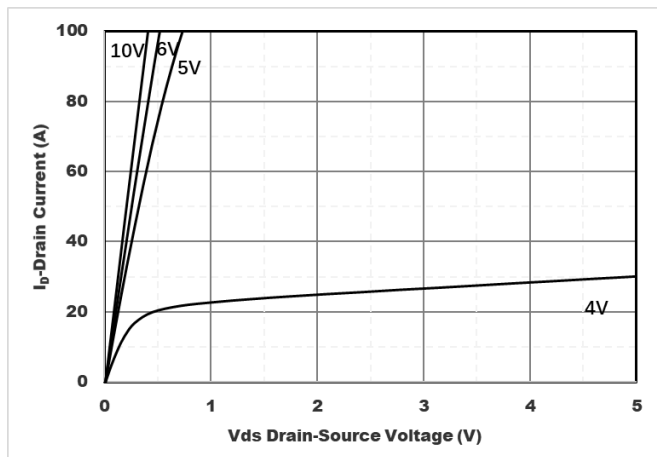


Figure1. Output Characteristics

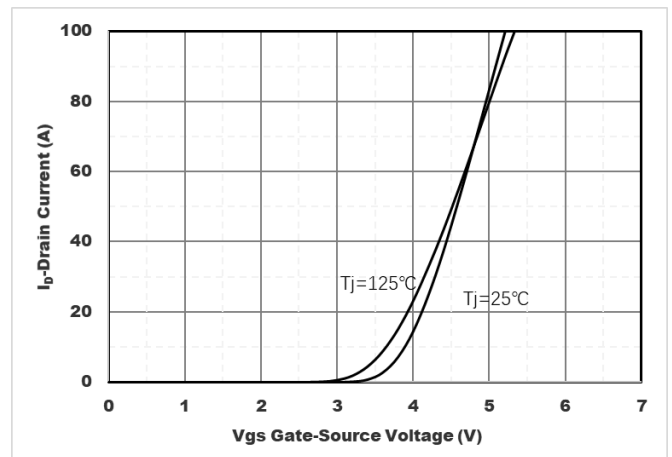


Figure2. Transfer Characteristics

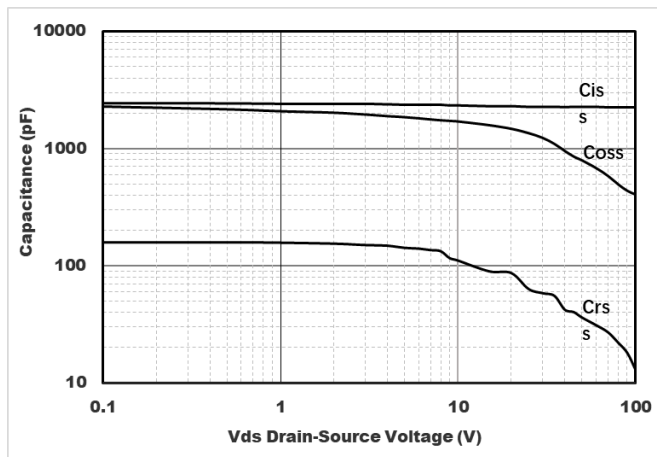


Figure3. Capacitance Characteristics

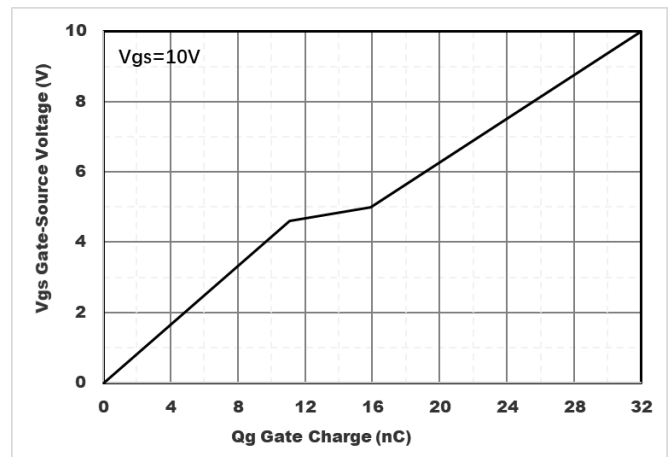


Figure4. Gate Charge

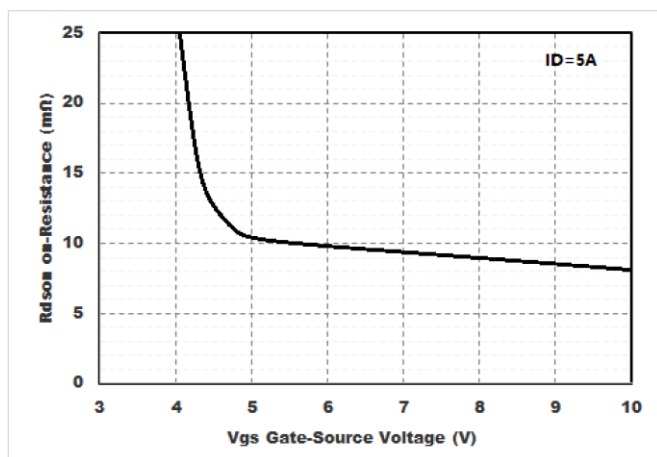


Figure5. Drain-Source on Resistance

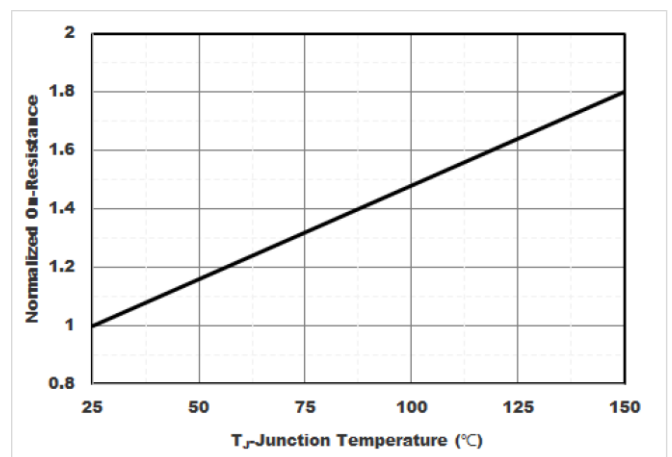


Figure6. Drain Current

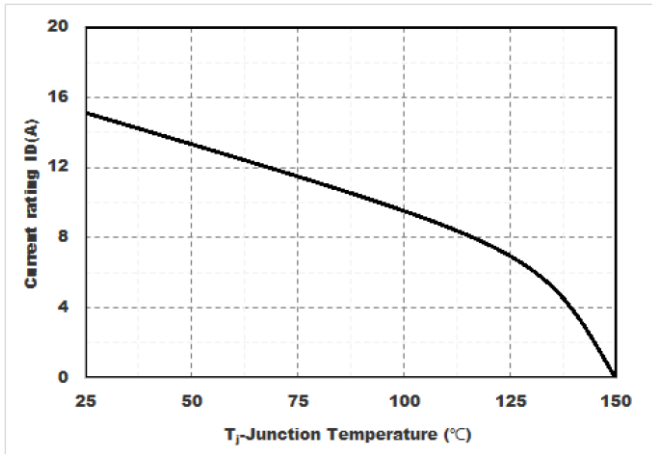


Figure7. Drain current

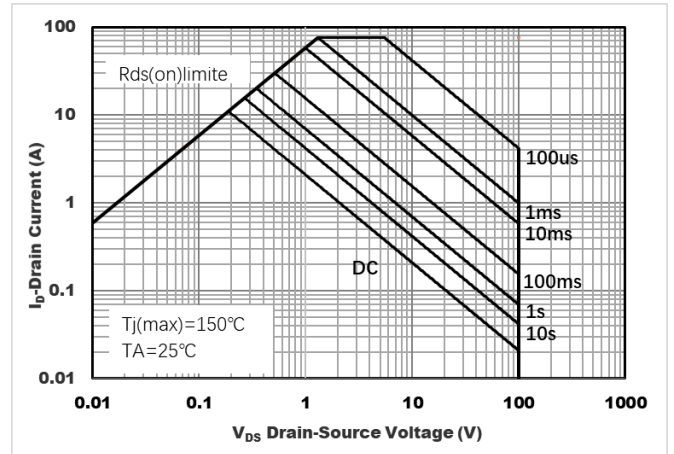


Figure8. Safe Operation Area

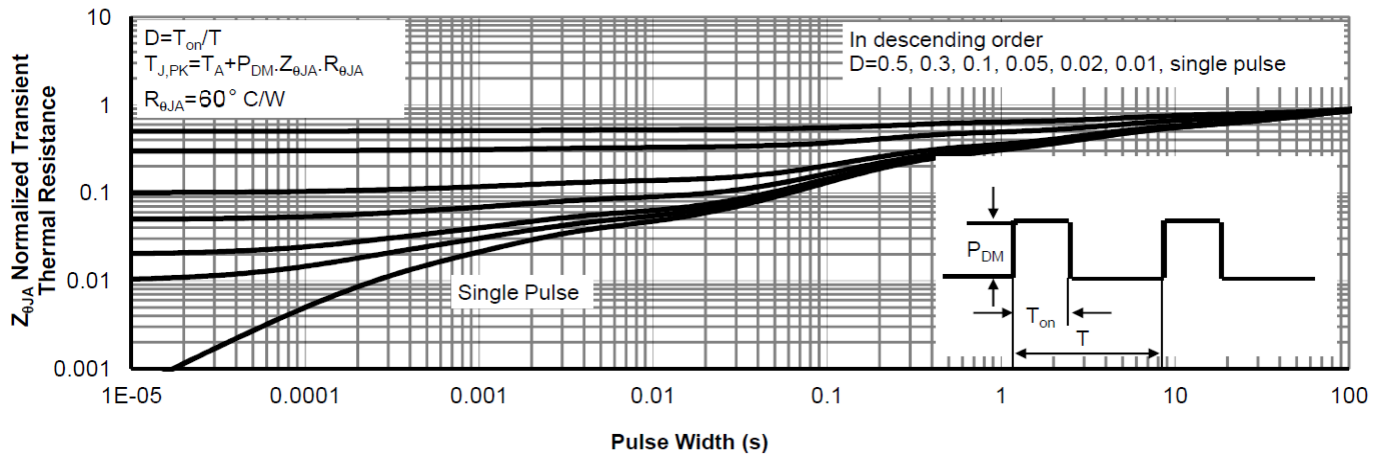
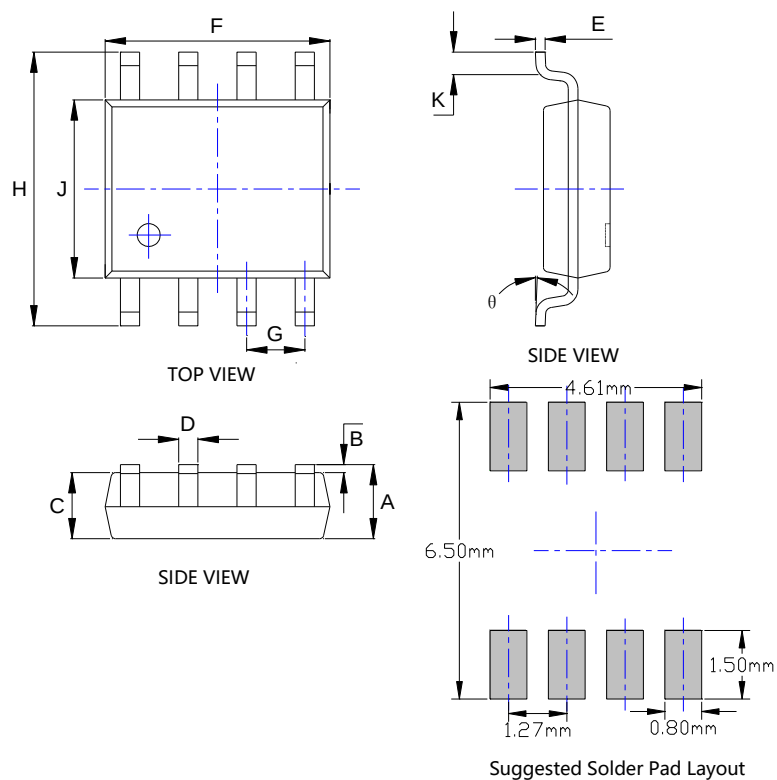


Figure9. Normalized Maximum Transient Thermal Impedance

■ SOP-8 Package information



SYMBOL	DIMENSIONS			
	INCHES		Millimeter	
	MIN.	MAX.	MIN.	MAX.
A	0.053	0.069	1.350	1.750
B	0.004	0.010	0.100	0.250
C	0.053	0.061	1.350	1.550
D	0.013	0.020	0.330	0.510
E	0.007	0.010	0.170	0.250
F	0.189	0.197	4.800	5.000
G	0.050BSC		1.270BSC	
H	0.228	0.244	5.800	6.200
J	0.150	0.157	3.800	4.000
K	0.016	0.050	0.400	1.270
θ	0°	8°	0°	8°

Note:

1. Controlling dimension: in millimeters.
2. General tolerance: $\pm 0.05\text{mm}$.
3. The pad layout is for reference purposes only.

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